SLVS312A - JULY 2000 - REVISED DECEMBER 2002

- Overvoltage Protection and Lockout for 12 V, 5 V, 3.3 V
- Undervoltage Protection and Lockout for 5 V and 3.3 V
- Fault Protection Output With Open-Drain Output Stage
- Open-Drain Power Good Output Signal for Power Good Input, 3.3 V and 5 V
- Power Good Delay; 300-ms TPS3510, 150-ms TPS3511
- 75-ms Delay for 5-V and 3.3-V Power Supply Short-Circuit Turnon Protection
- 2.3-ms PSON Control to FPO Turnoff Delay
- 38-ms PSON Control Debounce
- 73-µs Width Noise Deglitches
- Wide Supply Voltage Range From 4 V to 15 V

description

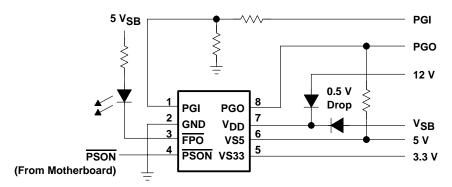
The TPS3510/1 is designed to minimize external components of personal-computer switching power supply systems. It provides protection circuits, power good indicator, fault protection output (FPO) and PSON control.

Overvoltage protection (OVP) monitors 3.3 V, 5 V, and 12 V (12-V signal detects via V_{DD} pin). Undervoltage protection (UVP) monitors 3.3 V and 5 V. When an OV or UV condition is detected, the power good output (PGO) is set to low and \overline{FPO} is latched high. \overline{PSON} from low to high resets the protection latch. UVP function is enabled 75 ms after \overline{PSON} is set low and debounced. Furthermore, there is a 2.3-ms delay (and an additional 38-ms debounce) at turnoff. There is no delay during turnon.

Power good feature monitors PGI, 3.3 V and 5 V and issues a power good signal when the output is ready.

The TPS3510/1 is characterized for operation from -40°C to 85°C.

typical application





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SLVS312A – JULY 2000 – REVISED DECEMBER 2002

FUNCTION TABLE

PGI	PSON	UV CONDITION (3.3 V OR 5 V)	OV CONDITION (3.3 V, 5 V, OR 12 V)	FPO	PGO
<0.95 V	L	no	no	L	L
<0.95 V	L	no	yes	Н	L
<0.95 V	L	yes	no	L	L
0.95 V <pgi<1.15 td="" v<=""><td>L</td><td>no</td><td>no</td><td>L</td><td>L</td></pgi<1.15>	L	no	no	L	L
0.95 V <pgi<1.15 td="" v<=""><td>L</td><td>no</td><td>yes</td><td>Н</td><td>L</td></pgi<1.15>	L	no	yes	Н	L
0.95 V <pgi<1.15 td="" v<=""><td>L</td><td>yes</td><td>no</td><td>Н</td><td>L</td></pgi<1.15>	L	yes	no	Н	L
PGI > 1.15 V	L	no	no	L	Н
PGI > 1.15 V	L	no	yes	Н	L
PGI > 1.15 V	L	yes	no	Н	L
Х	Н	х	Х	Н	L

x = don't care

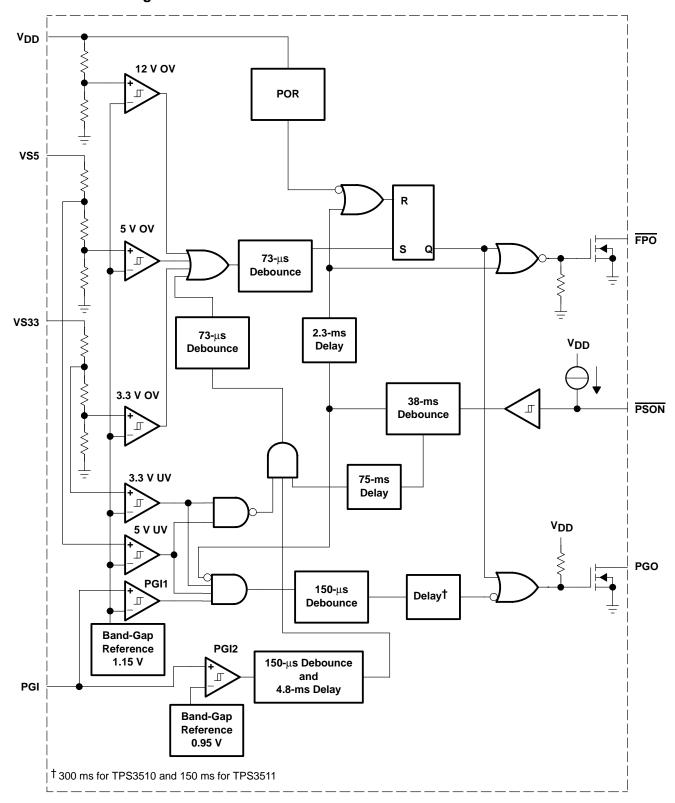
FPO = L means: fault IS NOT latched

FPO = H means: fault IS latched

PGO = L means: fault PGO = H means: NO fault

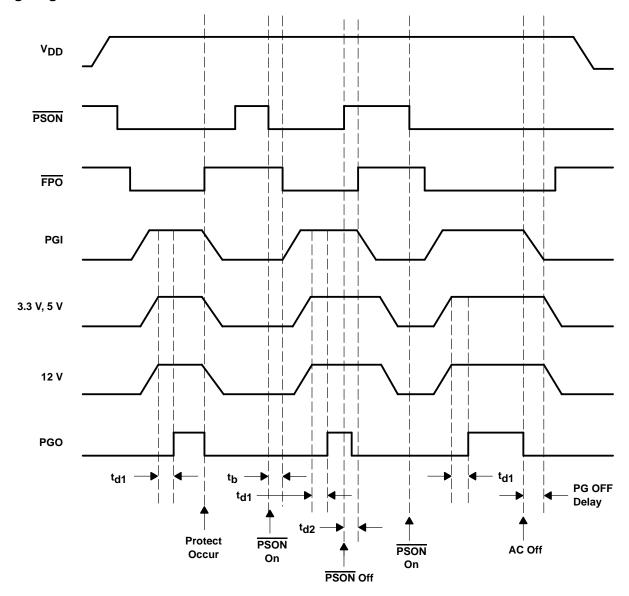


functional block diagram





timing diagram



Terminal Functions

TERMIN	IAL		DECODINE				
NAME	NO.	1/0	DESCRIPTION				
FPO	3	0	Inverted fault protection output, open drain output stage				
GND	2		Ground				
PGI	1	ı	Power good input				
PGO	8	0	Power good output, open drain output stage				
PSON	4	1	ON/OFF control				
V_{DD}	7	1	Supply voltage/12 V overvoltage protection input pin				
VS33	5	I	3.3 V over/undervoltage protection				
VS5	6	I	5 V over/undervoltage protection				



detailed description

power good and power good delay

A PC power supply is commonly designed to provide a power-good signal, which is defined by the computer manufacturers. PGO is a power-good signal and should be asserted high by the PC power supply to indicate that the 5-V and 3.3-V outputs are above the under-voltage threshold limit. At this time the converter should be able to provide enough power to ensure continuous operation within the specification. Conversely, when either the 5-V or the 3.3-V output voltages fall below the under-voltage threshold, or when ac power has been removed for a time sufficiently long so that power supply operation is no longer ensured, PGO should be de-asserted to a low state.

Figure 1 represents the timing characteristics of the power good (PGO), dc enable (\overline{PSON}), and the 5 V/3.3 V supply rails.

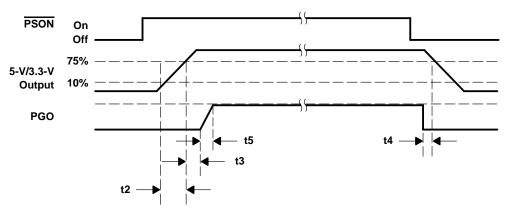


Figure 1. Timing of PSON and PGO

Although there is no requirement to meet specific timing parameters, the following signal timings are recommended:

 $2 \text{ ms} \le t2 \le 20 \text{ ms}$, 100 ms < t3 < 2000 ms, t4 > 1 ms, $t5 \le 10 \text{ ms}$

Furthermore motherboards should be designed to comply with the previously recommended timing. If timings other than these are implemented or required, this information should be clearly specified.

The TPS3510/1 family of power-supply supervisors provides a power-good output (PGO) for the 3.3-V and 5-V supply voltage rails and a separate power-good input (PGI). An internal timer is used to generate a power-good delay. If the voltage signals at PGI, VS33, and VS5 rise above the under-voltage threshold, the open-drain power-good output (PGO) goes high after a delay of 150 ms or 300 ms. When the PGI voltage or either the 3.3-V and 5-V power rails drops below the under-voltage threshold, PGO is disabled immediately (after 150- μ s debounce).

power supply remote on/off (PSON) and fault protect output (FPO)

Since the latest personal computer generation focuses on easy turnon and power saving functions, the PC power supply requires two characteristics. One is a dc power supply remote on/off function, the other is standby voltage to achieve very low power consumption of the PC system. Thus the main power needs to be shut down.

The power supply remote on/off (\overline{PSON}) is an active low signal that turns on all of the main power rails including 3.3 V, 5 V, -5 V, 12 V, and -12 V power rails. When this signal is held high by the PC motherboard or left open circuited, the signal of the fault protect output (\overline{FPO}) also goes high. Thus, the main power rails should not deliver current and should be held at 0 V.

SLVS312A - JULY 2000 - REVISED DECEMBER 2002

power supply remote on/off (PSON) and fault protect output (FPO)(continued)

When the FPO signal is held high due to an occurring fault condition, the fault status is latched and the outputs of the main power rails should not deliver current but are held at 0 V. Toggling the power supply remote on/off (PSON) from low to high resets the fault-protection latch. During this fault condition only the standby power is not affected.

When $\overline{\text{PSON}}$ goes from high to low or low to high, the 38-ms debounce block is active to avoid a glitch on the input that disables/enables the $\overline{\text{FPO}}$ output. During this period the under-voltage function is disabled for 75 ms to prevent turnon failure. At turnoff, there is an additional delay of 2.3 ms from $\overline{\text{PSON}}$ to $\overline{\text{FPO}}$.

Power should be delivered to the rails only if the PSON signal is held at ground potential, thus FPO is active-low. The FPO pin can be connected to 5 V (or up to 15 V) through a pullup resistor.

undervoltage protection

The TPS3510/1 provides under-voltage protection (UVP) for the 3.3-V and 5-V rails. When an undervoltage condition appears at either one of the 3.3-V (VS33) or 5-V (VS5) input pins for more than 146 μ s, the FPO output goes high and PGO goes low. Also, this fault condition is latched until PSON is toggled from low to high or V_{DD} is removed.

The need for undervoltage protection is often overlooked in off-line switching power supply system design. But it is very important in battery-powered or hand-held equipment since the TTL or CMOS logic often results in malfunction.

In flyback or forward-type off-line switching power supplies, usually designed for low power, the overload protection design is very simple. Most of these types of power supplies are only sensing the input current for an overload condition. The trigger point needs to be set much higher than the maximum load in order to prevent false turnon.

However, this causes one critical problem. If the connected load is larger than the maximum allowable load but smaller than the trigger point, the system always becomes overheated with failure and damage occurring.

overvoltage protection

The overvoltage protection (OVP) of TPS3510/1 monitors 3.3 V, 5 V, and 12 V (12 V is sensed via the V_{DD} pin). When an overvoltage condition appears at one of the 3.3-V, 5-V, or 12-V input pins for more than 73 μ s, the FPO output goes high and PGO goes low. Also, this fault condition is latched until PSON is toggled from low to high or V_{DD} is removed. During fault conditions, most power supplies have the potential to deliver higher output voltages than those normally specified or required. In unprotected equipment, it is possible for output voltages to be high enough to cause internal or external damage of the system. To protect the system under these abnormal conditions, it is common practice to provide overvoltage protection within the power supply.

Because TTL and CMOS circuits are very vulnerable to overvoltages, it is becoming industry standard to provide overvoltage protection on all 3.3-V and 5-V outputs. However, not only the 3.3-V and 5-V rails for the logic circuits on the motherboard need to be protected, but also the 12-V peripheral devices such as the hard disk, floppy disk, and CD-ROM players etc., need to be protected.

short-circuit power supply turnon

During safety testing the power supply might have tied the output voltage direct to ground. If this happens during the normal operating, this is called a short-circuit or over-current condition. When it happens before the power supply turns on, this is called a short-circuit power supply turnon. It can happen during the design period, in the production line, at quality control inspection or at the end user. The TPS3510/1 provides an undervoltage protection function with a 75-ms delay after $\overline{\text{PSON}}$ is set low.



SLVS312A – JULY 2000 – REVISED DECEMBER 2002

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V _{DD} (see Note1)	16 V
Output voltage VO: FPO	16 V
	8 V
All other pins (see Note 1)	0.3 V to 16 V
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, T _A	–40°C to 85°C
Storage temperature range, T _{stq}	–65°C to 150°C
Soldering temperature	260°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute—maximum—rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to GND.

DISSIPATION RATING TABLE

PACKAGE	$T_{\mbox{A}} \le 25^{\circ}\mbox{C}$ POWER RATING	DERATING FACTOR ABOVE T _A = 25°C	T _A = 70°C POWER RATING	T _A = 85°C POWER RATING
Р	1092 mW	8.74 mW/°C	699 mW	568 mW
D	730 mW	5.84 mW/°C	467 mW	379 mW

recommended operating conditions at specified temperature range

		MIN NOM	MAX	UNIT
Supply voltage, V _{DD}		4	15	V
	PSON, VS5, VS33		7	
Input voltage, V _I	PGI	V _{DE}	4 15 V 7 VDD + 0.3 V (max = 7 V) 15 7 V 20 10 1 ms	V
Outroducella con M	FPO		15	.,
Output voltage, VO	PGO		4 15 7 VDD + 0.3 V (max = 7 V) 15 7 20 10	V
0	FPO		20	
Output sink current, I _{O,sink}	PGO		10	
Supply voltage rising time, t _r	See Note 2	1		ms
Operating free-air temperature range,	^r A	-40	85	°C

NOTE 2: $V_{\mbox{DD}}$ rising and falling slew rate must be less than 14 V/ms.

SLVS312A – JULY 2000 – REVISED DECEMBER 2002

electrical characteristics over recommended operating conditions (unless otherwise noted)

overvoltage protection

	PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
	VS33		3.7	3.9	4.1		
	Overvoltage threshold	VS5		5.7	6.1	6.5	V
				13.2	13.8	14.4	
ILKG	Leakage current (FPO)		V(FPO) = 5 V			5	μΑ
VOL	Low-level output voltage (FPO)		$V_{DD} = 5 \text{ V}, I_{sink} = 20 \text{ mA}$			0.7	V
	Noise deglitch time OVP	_	V _{DD} = 5 V	35	73	110	μs

PGI and PGO

	PARAMETI	R		TEST CONDITIONS	MIN	TYP	MAX	UNIT
, , , , , , , , , , , , , , , , , , ,	PGI Input threshold voltage (PGI)		PGI1		1.1	1.15	1.2	V
VPGI			PGI2		0.9	0.95	1	
, , , , , , , , , , , , , , , , , , ,	V _{IT} Undervoltage threshold		VS33		2	2.2	2.4	,,
VIT			VS5		3.3	3.5	3.7	V
I _{LKG}	Leakage current (PGO)			PGO = 5 V			5	μΑ
VOL	Low-level output voltage (PGO)		_	$V_{DD} = 4 \text{ V}, I_{sink} = 10 \text{ mA}$			0.4	V
	Short-circuit protection delay		3.3 V, 5 V		49	75	114	ms
		TP3510	DOLLA DOO		200	300	450	
t _{d1}	Delay time	TP3511	PGI to PGO	V _{DD} = 5 V	100	150	225	ms
			PGI to FPO]	3.2	4.8	7.2	!
			PGI to PGO		88	150	225	
	Noise deglitch time		PGI to FPO	V _{DD} = 5 V	180	296	445	μs
			UVP to FPO]	82	146	220	

PSON control

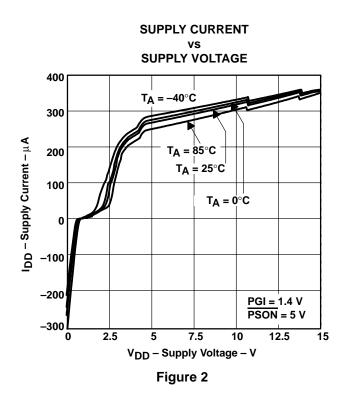
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
lį	Input pullup current	PSON = 0 V		120		μΑ
VIН	High-level input voltage		2.4			V
V_{IL}	Low-level input voltage				1.2	V
t _b	Debounce time (PSON)	V _{DD} = 5 V	24	38	57	ms
t _{d2}	Delay time (PSON to FPO)	V _{DD} = 5 V	t _b +1.1	t _b +2.3	t _b +4	ms

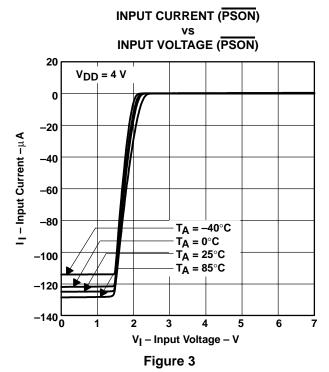
total device

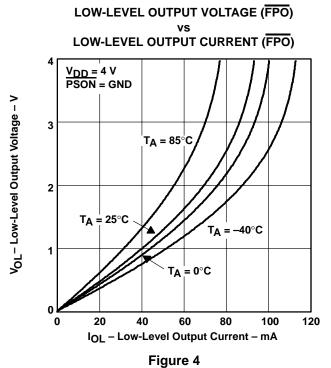
	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
I_{DD}	Supply current	PSON = 5 V			1	mA

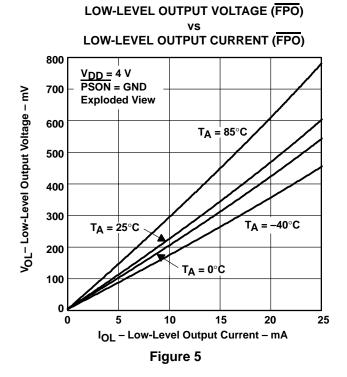


TYPICAL CHARACTERISTICS

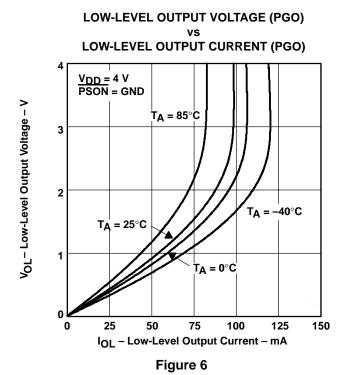




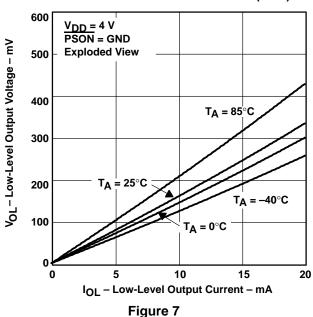




TYPICAL CHARACTERISTICS



LOW-LEVEL OUTPUT VOLTAGE (PGO) vs LOW-LEVEL OUTPUT CURRENT (PGO)



NORMALIZED SENSE THRESHOLD VOLTAGE

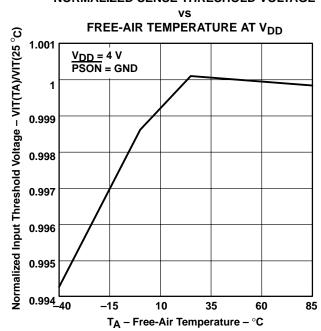


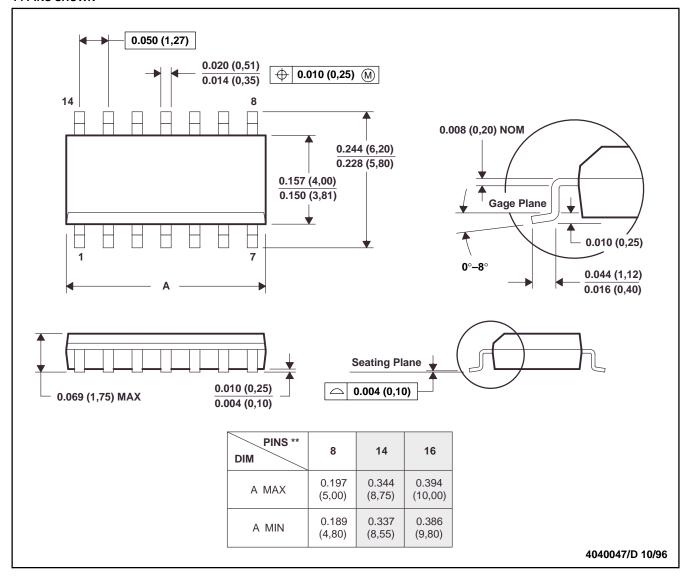
Figure 8

MECHANICAL DATA

D (R-PDSO-G**)

14 PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

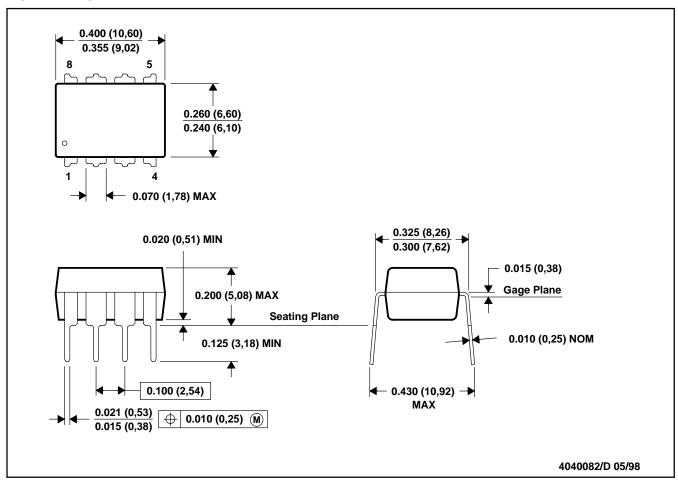
C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012

SLVS312A – JULY 2000 – REVISED DECEMBER 2002

MECHANICAL DATA

P (R-PDIP-T8) PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001

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